



# DS1302 Trickle Charge Timekeeping Chip

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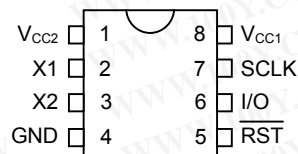
## FEATURES

- Real-time clock (RTC) counts seconds, minutes hours, date of the month, month, day of the week, and year with leap-year compensation valid up to 2100
- 31-byte, battery-backed, nonvolatile (NV) RAM for data storage
- Serial I/O for minimum pin count
- 2.0V to 5.5V full operation
- Uses less than 300nA at 2.0V
- Burst mode for reading/writing successive addresses in clock/RAM
- 8-pin DIP or optional 8-pin SOICs for surface mount
- Simple 3-wire interface
- TTL-compatible ( $V_{CC} = 5V$ )
- Optional industrial temperature range:  $-40^{\circ}C$  to  $+85^{\circ}C$
- DS1202 compatible
- Underwriters Laboratory (UL) recognized

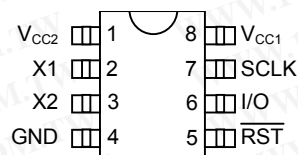
## ORDERING INFORMATION

DS1302	8-Pin DIP (300-mil)
DS1302N	8-Pin DIP (Industrial)
DS1302S	8-Pin SOIC (200-mil)
DS1302SN	8-Pin SOIC (Industrial)
DS1302Z	8-Pin SOIC (150-mil)
DS1302ZN	8-Pin SOIC (Industrial)
DS1302S-16	16-Pin SOIC (300-mil)
DS1302SN-16	16-Pin SOIC (Industrial)

## PIN ASSIGNMENT

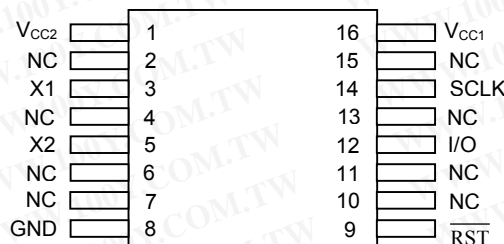


DS1302 8-Pin DIP (300-mil)



DS1302 8-Pin SOIC (200-mil)

DS1302 8-Pin SOIC (150-mil)



DS1302 16-Pin SOIC (300-mil)

## PIN DESCRIPTION

X1, X2	- 32.768kHz Crystal Pins
GND	- Ground
RST	- Reset
I/O	- Data Input/Output
SCLK	- Serial Clock
$V_{CC1}$ , $V_{CC2}$	- Power Supply Pins

## DESCRIPTION

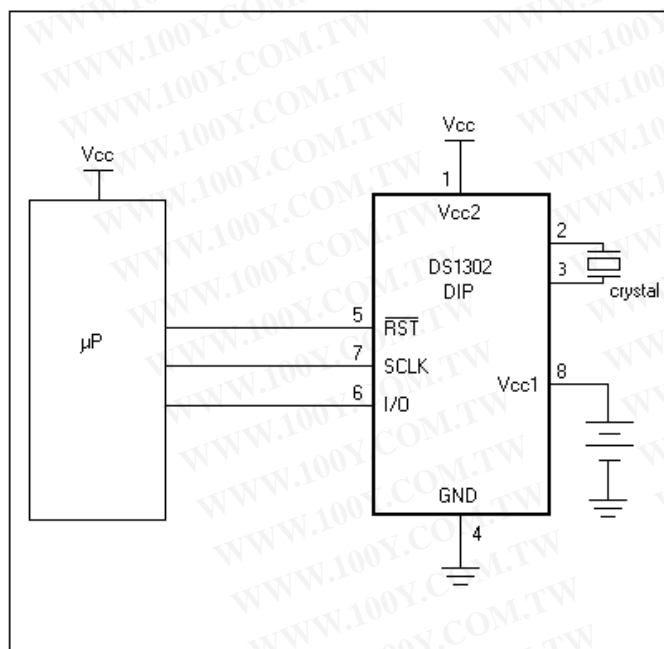
The DS1302 Trickle Charge Timekeeping Chip contains an RTC/calendar and 31 bytes of static RAM. It communicates with a microprocessor via a simple serial interface. The RTC/calendar provides seconds, minutes, hours, day, date, month, and year information. The end of the month date is automatically adjusted for months with fewer than 31 days, including corrections for leap year. The clock operates in either the 24-hour or 12-hour format with an AM/PM indicator.

Interfacing the DS1302 with a microprocessor is simplified by using synchronous serial communication.

Only three wires are required to communicate with the clock/RAM: 1)  $\overline{\text{RST}}$  (reset), 2) I/O (data line), and 3) SCLK (serial clock). Data can be transferred to and from the clock/RAM 1 byte at a time or in a burst of up to 31 bytes. The DS1302 is designed to operate on very low power and retain data and clock information on less than 1 microwatt.

The DS1302 is the successor to the DS1202. In addition to the basic timekeeping functions of the DS1202, the DS1302 has the additional features of dual-power pins for primary and back-up power supplies, programmable trickle charger for  $V_{CC1}$ , and seven additional bytes of scratchpad memory.

## TYPICAL OPERATING CIRCUIT

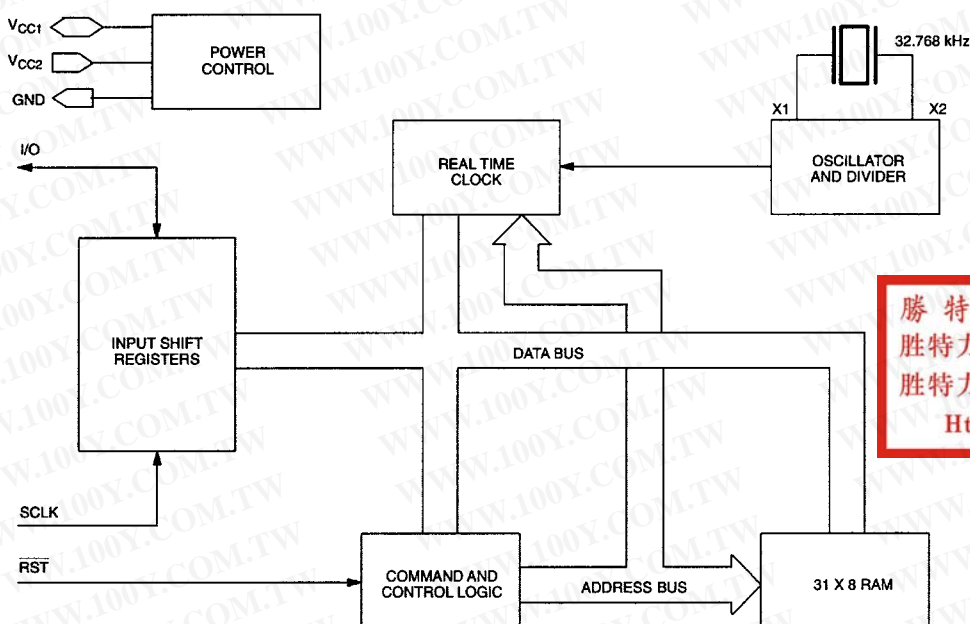


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## OPERATION

The main elements of the serial timekeeper (i.e., shift register, control logic, oscillator, RTC, and RAM) are shown in Figure 1.

## DS1302 BLOCK DIAGRAM Figure 1



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## SIGNAL DESCRIPTIONS

**V<sub>CC1</sub>** – V<sub>CC1</sub> provides low-power operation in single supply and battery-operated systems as well as low-power battery backup. In systems using the trickle charger, the rechargeable energy source is connected to this pin. UL recognized to ensure against reverse charging current when used in conjunction with a lithium battery.

See “Conditions of Acceptability” at <http://www.maxim-ic.com/TechSupport/QA/ntrl.htm>.

**V<sub>CC2</sub>** – V<sub>CC2</sub> is the primary power supply pin in a dual-supply configuration. V<sub>CC1</sub> is connected to a backup source to maintain the time and date in the absence of primary power.

The DS1302 will operate from the larger of V<sub>CC1</sub> or V<sub>CC2</sub>. When V<sub>CC2</sub> is greater than V<sub>CC1</sub> + 0.2V, V<sub>CC2</sub> will power the DS1302. When V<sub>CC2</sub> is less than V<sub>CC1</sub>, V<sub>CC1</sub> will power the DS1302.

**SCLK (Serial Clock Input)** – SCLK is used to synchronize data movement on the serial interface. This pin has a 40kΩ internal pull-down resistor.

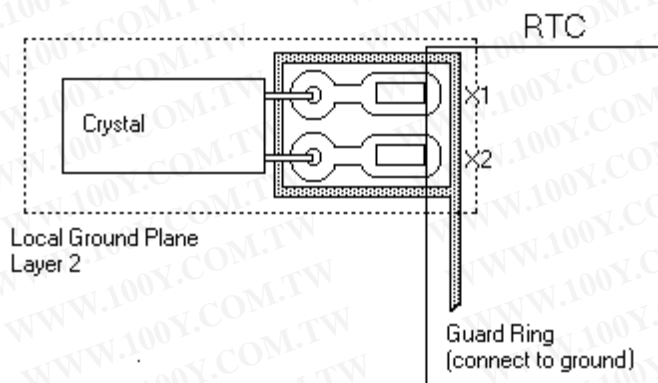
**I/O (Data Input/Output)** – The I/O pin is the bi-directional data pin for the 3-wire interface. This pin has a 40kΩ internal pull-down resistor.

**RST (Reset)** – The reset signal must be asserted high during a read or a write. This pin has a 40kΩ internal pull-down resistor.

**X1, X2** – Connections for a standard 32.768kHz quartz crystal. The internal oscillator is designed for operation with a crystal having a specified load capacitance of 6pF. For more information on crystal selection and crystal layout considerations, please consult Application Note 58, “Crystal Considerations

with Dallas Real-Time Clocks.” The DS1302 can also be driven by an external 32.768kHz oscillator. In this configuration, the X1 pin is connected to the external oscillator signal and the X2 pin is floated.

## RECOMMENDED LAYOUT FOR CRYSTAL



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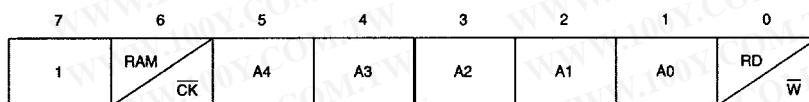
## CLOCK ACCURACY

The accuracy of the clock is dependent upon the accuracy of the crystal and the accuracy of the match between the capacitive load of the oscillator circuit and the capacitive load for which the crystal was trimmed. Additional error will be added by crystal frequency drift caused by temperature shifts. External circuit noise coupled into the oscillator circuit may result in the clock running fast. See Application Note 58, “Crystal Considerations with Dallas Real-Time Clocks” for detailed information.

## COMMAND BYTE

The command byte is shown in Figure 2. Each data transfer is initiated by a command byte. The MSB (Bit 7) must be a logic 1. If it is 0, writes to the DS1302 will be disabled. Bit 6 specifies clock/calendar data if logic 0 or RAM data if logic 1. Bits 1 through 5 specify the designated registers to be input or output, and the LSB (bit 0) specifies a write operation (input) if logic 0 or read operation (output) if logic 1. The command byte is always input starting with the LSB (bit 0).

## ADDRESS/COMMAND BYTE Figure 2



## RESET AND CLOCK CONTROL

All data transfers are initiated by driving the  $\overline{\text{RST}}$  input high. The  $\overline{\text{RST}}$  input serves two functions. First,  $\overline{\text{RST}}$  turns on the control logic, which allows access to the shift register for the address/command sequence. Second, the  $\overline{\text{RST}}$  signal provides a method of terminating either single byte or multiple byte data transfer.

A clock cycle is a sequence of a falling edge followed by a rising edge. For data inputs, data must be valid during the rising edge of the clock and data bits are output on the falling edge of clock. If the  $\overline{\text{RST}}$  input is low all data transfer terminates and the I/O pin goes to a high impedance state. Data transfer is illustrated in Figure 3. At power-up,  $\overline{\text{RST}}$  must be a logic 0 until  $V_{CC} > 2.0V$ . Also SCLK must be at a logic 0 when  $\overline{\text{RST}}$  is driven to a logic 1 state.



## DATA INPUT

Following the eight SCLK cycles that input a write command byte, a data byte is input on the rising edge of the next eight SCLK cycles. Additional SCLK cycles are ignored should they inadvertently occur. Data is input starting with bit 0.

## DATA OUTPUT

Following the eight SCLK cycles that input a read command byte, a data byte is output on the falling edge of the next eight SCLK cycles. Note that the first data bit to be transmitted occurs on the first falling edge after the last bit of the command byte is written. Additional SCLK cycles retransmit the data bytes should they inadvertently occur so long as RST remains high. This operation permits continuous burst mode read capability. Also, the I/O pin is tri-stated upon each rising edge of SCLK. Data is output starting with bit 0.

## BURST MODE

Burst mode may be specified for either the clock/calendar or the RAM registers by addressing location 31 decimal (address/command bits 1 through 5 = logic 1). As before, bit 6 specifies clock or RAM and bit 0 specifies read or write. There is no data storage capacity at locations 9 through 31 in the Clock/Calendar Registers or location 31 in the RAM registers. Reads or writes in burst mode start with bit 0 of address 0.

When writing to the clock registers in the burst mode, the first eight registers must be written in order for the data to be transferred. However, when writing to RAM in burst mode it is not necessary to write all 31 bytes for the data to transfer. Each byte that is written to will be transferred to RAM regardless of whether all 31 bytes are written or not.

## CLOCK/CALENDAR

The clock/calendar is contained in seven write/read registers as shown in Figure 4. Data contained in the clock/ calendar registers is in binary coded decimal format (BCD).

## CLOCK HALT FLAG

Bit 7 of the seconds register is defined as the clock halt flag. When this bit is set to logic 1, the clock oscillator is stopped and the DS1302 is placed into a low-power standby mode with a current drain of less than 100 nanoamps. When this bit is written to logic 0, the clock will start. The initial power on state is not defined.

## AM-PM/12-24 MODE

Bit 7 of the hours register is defined as the 12- or 24-hour mode select bit. When high, the 12-hour mode is selected. In the 12-hour mode, bit 5 is the AM/PM bit with logic high being PM. In the 24-hour mode, bit 5 is the second 10-hour bit (20–23 hours).

## WRITE PROTECT BIT

Bit 7 of the control register is the write-protect bit. The first seven bits (bits 0–6) are forced to 0 and will always read a 0 when read. Before any write operation to the clock or RAM, bit 7 must be 0. When high, the write protect bit prevents a write operation to any other register. The initial power on state is not defined. Therefore the WP bit should be cleared before attempting to write to the device.

## TRICKLE CHARGE REGISTER

This register controls the trickle charge characteristics of the DS1302. The simplified schematic of Figure 5 shows the basic components of the trickle charger. The trickle charge select (TCS) bits (bits 4–7) control the selection of the trickle charger. In order to prevent accidental enabling, only a pattern of 1010 will enable the trickle charger. All other patterns will disable the trickle charger. The

DS1302 powers up with the trickle charger disabled. The diode select (DS) bits (bits 2–3) select whether one diode or two diodes are connected between  $V_{CC2}$  and  $V_{CC1}$ . If DS is 01, one diode is selected or if DS is 10, two diodes are selected. If DS is 00 or 11, the trickle charger is disabled independently of TCS. The RS bits (bits 0–1) select the resistor that is connected between  $V_{CC2}$  and  $V_{CC1}$ . The resistor selected by the resistor select (RS) bits is as follows:

RS Bits	Resistor	Typical Value
00	None	None
01	R1	2k $\Omega$
10	R2	4k $\Omega$
11	R3	8k $\Omega$

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If RS is 00, the trickle charger is disabled independently of TCS.

Diode and resistor selection is determined by the user according to the maximum current desired for battery or super cap charging. The maximum charging current can be calculated as illustrated in the following example. Assume that a system power supply of 5V is applied to  $V_{CC2}$  and a super cap is connected to  $V_{CC1}$ . Also assume that the trickle charger has been enabled with one diode and resistor R1 between  $V_{CC2}$  and  $V_{CC1}$ . The maximum current  $I_{MAX}$  would, therefore, be calculated as follows:

$$I_{MAX} = (5.0V - \text{diode drop})/R1 \approx (5.0V - 0.7V) / 2k\Omega \approx 2.2mA$$

As the super cap charges, the voltage drop between  $V_{CC1}$  and  $V_{CC2}$  will decrease and, therefore, the charge current will decrease.

## CLOCK/CALENDAR BURST MODE

The clock/calendar command byte specifies burst mode operation. In this mode the first eight clock/calendar registers can be consecutively read or written (See Figure 4) starting with bit 0 of address 0.

If the write protect bit is set high when a write clock/calendar burst mode is specified, no data transfer will occur to any of the eight clock/calendar registers (this includes the control register). The trickle charger is not accessible in burst mode.

At the beginning of a clock burst read, the current time is transferred to a second set of registers. The time information is read from these secondary registers, while the clock may continue to run. This eliminates the need to re-read the registers in case of an update of the main registers during a read.

## RAM

The static RAM is 31 x 8 bytes addressed consecutively in the RAM address space.

## RAM BURST MODE

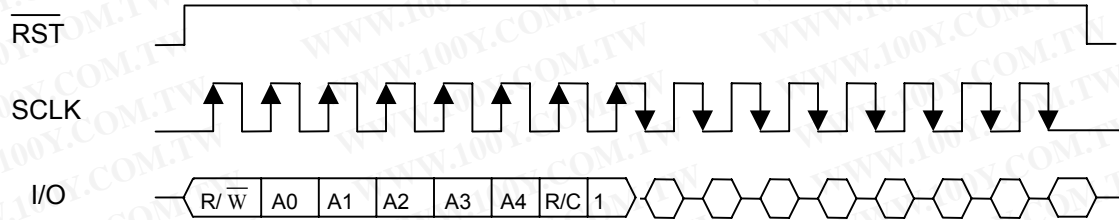
The RAM command byte specifies burst mode operation. In this mode, the 31 RAM registers can be consecutively read or written (See Figure 4) starting with bit 0 of address 0.

## REGISTER SUMMARY

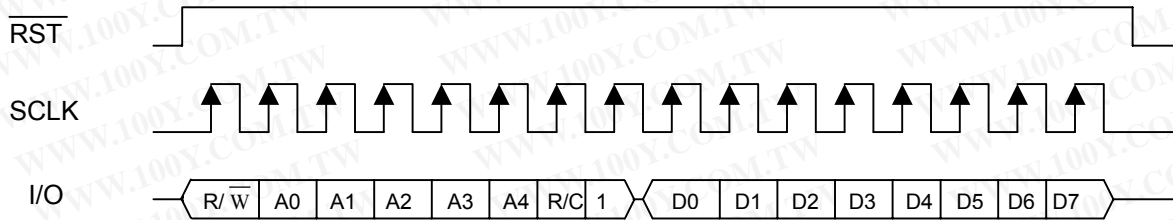
A register data format summary is shown in Figure 4.

## DATA TRANSFER SUMMARY Figure 3

### SINGLE BYTE READ



### SINGLE BYTE WRITE



In burst mode,  $\overline{\text{RST}}$  is kept high and additional  $\text{SCLK}$  cycles are sent until the end of the burst.

# REGISTER ADDRESS/DEFINITION Figure 4

## REGISTER ADDRESS

### A. CLOCK

	7	6	5	4	3	2	1	0
SEC	1	0	0	0	0	0	0	RD W
MIN	1	0	0	0	0	0	1	RD W
HR	1	0	0	0	0	1	0	RD W
DATE	1	0	0	0	0	1	1	RD W
MONTH	1	0	0	0	1	0	0	RD W
DAY	1	0	0	0	1	0	1	RD W
YEAR	1	0	0	0	1	1	0	RD W
CONTROL	1	0	0	0	1	1	1	RD W
TRICKLE CHARGER	1	0	0	1	0	0	0	RD W
CLOCK BURST	1	0	1	1	1	1	1	RD W

### B. RAM

RAM 0	1	1	0	0	0	0	0	RD W
RAM 30	1	1	1	1	1	1	0	RD W
RAM BURST	1	1	1	1	1	1	1	RD W

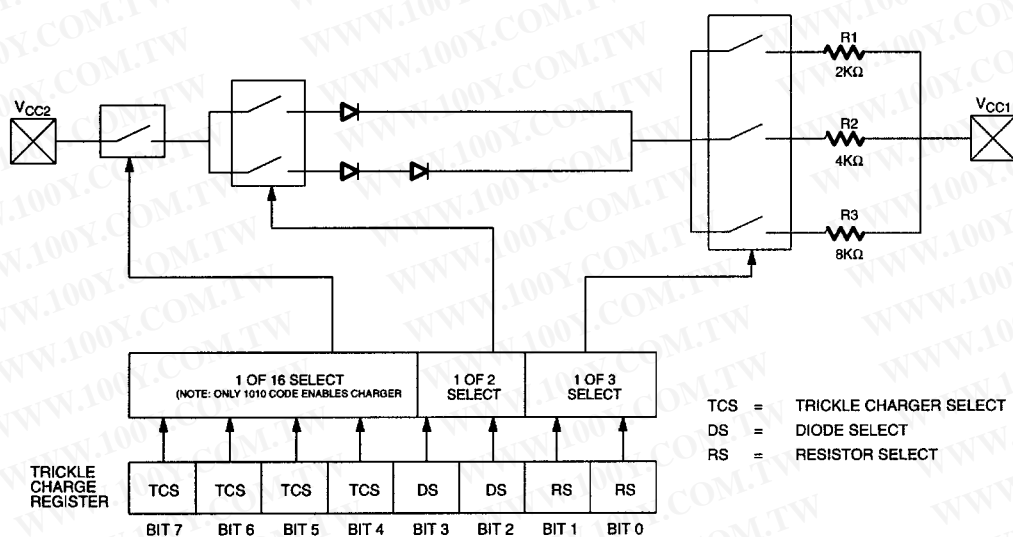
## REGISTER DEFINITION

00-59	CH	10 SEC	SEC				
00-59	0	10 MIN	MIN				
01-12 00-23	12/ 24	0	10 A/P	HR	HR		
01-28/29 01-30 01-31	0	0	10 DATE	DATE			
01-12	0	0	0	10 M	MONTH		
01-07	0	0	0	0	0	DAY	
00-99	10 YEAR			YEAR			
WP	0	0	0	0	0	0	0
TCS	TCS	TCS	TCS	DS	DS	RS	RS

RAM DATA 0							
RAM DATA 30							



## DS1302 PROGRAMMABLE TRICKLE CHARGER Figure 5



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## ABSOLUTE MAXIMUM RATINGS\*

Voltage on Any Pin Relative to Ground	-0.5V to +7.0V
Storage Temperature	-55°C to +125°C
Soldering Temperature	260°C for 10 seconds (DIP) See IPC/JEDEC Standard J-STD-020A for Surface Mount Devices

\* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

Range	Temperature	V <sub>CC</sub>
Commercial	0°C to 70°C	2.0V to 5.5V V <sub>CC1</sub> or V <sub>CC2</sub>
Industrial	-40°C to +85°C	2.0V to 5.5V V <sub>CC1</sub> or V <sub>CC2</sub>

## RECOMMENDED DC OPERATING CONDITIONS

(Over the operating range\*)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Supply Voltage V <sub>CC1</sub> , V <sub>CC2</sub>	V <sub>CC1</sub> , V <sub>CC2</sub>	2.0		5.5	V	8
Logic 1 Input	V <sub>IH</sub>	2.0		V <sub>CC</sub> + 0.3	V	
Logic 0 Input	V <sub>IL</sub>	V <sub>CC</sub> = 2.0V	-0.3	+0.3	V	
		V <sub>CC</sub> = 5V	-0.3	+0.8		

\*Unless otherwise specified.

## DC ELECTRICAL CHARACTERISTICS

(Over the operating range\*)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Leakage	I <sub>LI</sub>			+500	μA	3
I/O Leakage	I <sub>LO</sub>			+500	μA	3
Logic 1 Output I <sub>OH</sub> = -0.4mA I <sub>OH</sub> = -1.0mA	V <sub>OH</sub>	V <sub>CC</sub> = 2.0V	1.6		V	
		V <sub>CC</sub> = 5V	2.4			
Logic 0 Output I <sub>OL</sub> = 1.5mA I <sub>OL</sub> = 4.0mA	V <sub>OL</sub>	V <sub>CC</sub> = 2.0V		0.4	V	
		V <sub>CC</sub> = 5V		0.4		
Active Supply Current	I <sub>CC1A</sub>	V <sub>CC1</sub> = 2.0V		0.4	mA	2,9
		V <sub>CC1</sub> = 5V		1.2		
Timekeeping Current (OSC On)	I <sub>CC1T</sub>	V <sub>CC1</sub> = 2.0V		0.3	μA	1,9
		V <sub>CC1</sub> = 5V		1		
Standby Current (OSC Off)	I <sub>CC1S</sub>	V <sub>CC1</sub> = 2.0V		100	nA	7,9,11
		V <sub>CC1</sub> = 5V		100		
		IND		200		
Active Supply Current	I <sub>CC2A</sub>	V <sub>CC2</sub> = 2.0V		0.425	mA	2,10
		V <sub>CC2</sub> = 5V		1.28		
Timekeeping Current (OSC On)	I <sub>CC2T</sub>	V <sub>CC2</sub> = 2.0V		25.3	μA	1,10
		V <sub>CC2</sub> = 5V		81		
Standby Current (OSC Off)	I <sub>CC2S</sub>	V <sub>CC2</sub> = 2.0V		25	μA	7,10
		V <sub>CC2</sub> = 5V		80		

Trickle Charge Resistors	R1			2		k $\Omega$	
	R2			4		k $\Omega$	
	R3			8		k $\Omega$	
Trickle Charge Diode Voltage Drop	V <sub>TD</sub>			0.7		V	

\*Unless otherwise specified.

## CAPACITANCE

(T<sub>A</sub> = 25°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Input Capacitance	C <sub>I</sub>		10		pF	
I/O Capacitance	C <sub>I/O</sub>		15		pF	
Crystal Capacitance	C <sub>X</sub>		6		pF	

## AC ELECTRICAL CHARACTERISTICS

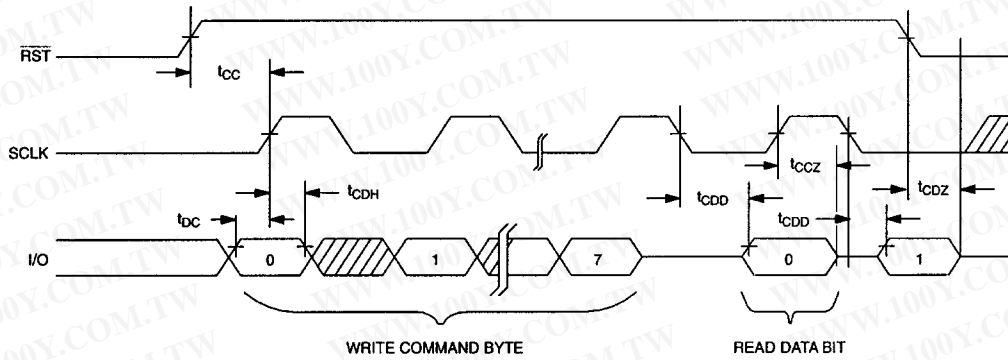
(Over the operating range\*)

PARAMETER	SYMBOL		MIN	TYP	MAX	UNITS	NOTES
Data to CLK Setup	t <sub>DC</sub>	V <sub>CC</sub> = 2.0V	200			ns	4
		V <sub>CC</sub> = 5V	50				
CLK to Data Hold	t <sub>CDH</sub>	V <sub>CC</sub> = 2.0V	280			ns	4
		V <sub>CC</sub> = 5V	70				
CLK to Data Delay	t <sub>CDD</sub>	V <sub>CC</sub> = 2.0V			800	ns	4,5,6
		V <sub>CC</sub> = 5V			200		
CLK Low Time	t <sub>CL</sub>	V <sub>CC</sub> = 2.0V	1000			ns	4
		V <sub>CC</sub> = 5V	250				
CLK High Time	t <sub>CH</sub>	V <sub>CC</sub> = 2.0V	1000			ns	4
		V <sub>CC</sub> = 5V	250				
CLK Frequency	t <sub>CLK</sub>	V <sub>CC</sub> = 2.0V			0.5	MHz	4
		V <sub>CC</sub> = 5V	DC		2.0		
CLK Rise and Fall	t <sub>R</sub> , t <sub>F</sub>	V <sub>CC</sub> = 2.0V			2000	ns	4
		V <sub>CC</sub> = 5V			500		
$\overline{\text{RST}}$ to CLK Setup	t <sub>CC</sub>	V <sub>CC</sub> = 2.0V	4			$\mu$ s	4
		V <sub>CC</sub> = 5V	1				
CLK to $\overline{\text{RST}}$ Hold	t <sub>CCH</sub>	V <sub>CC</sub> = 2.0V	240			ns	4
		V <sub>CC</sub> = 5V	60				
$\overline{\text{RST}}$ Inactive Time	t <sub>CWH</sub>	V <sub>CC</sub> = 2.0V	4			$\mu$ s	4
		V <sub>CC</sub> = 5V	1				
$\overline{\text{RST}}$ to I/O High-Z	t <sub>CDZ</sub>	V <sub>CC</sub> = 2.0V			280	ns	4
		V <sub>CC</sub> = 5V			70		
SCLK to I/O High-Z	t <sub>CCZ</sub>	V <sub>CC</sub> = 2.0V			280	ns	4
		V <sub>CC</sub> = 5V			70		

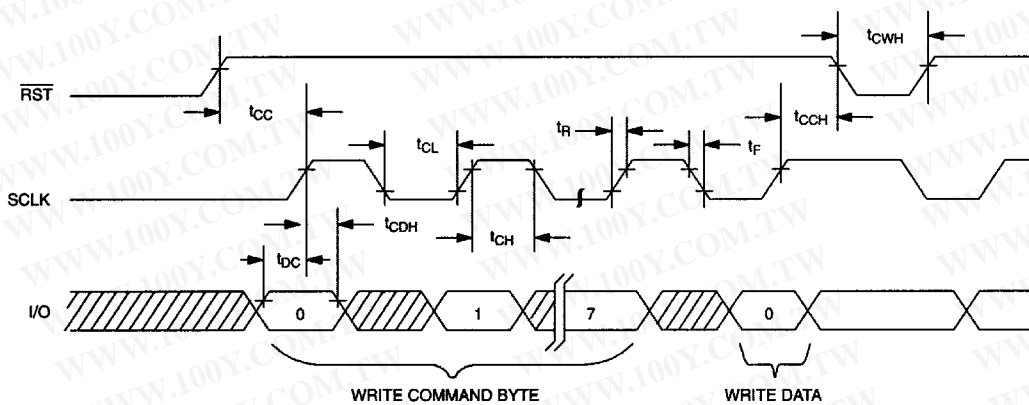
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## TIMING DIAGRAM: READ DATA TRANSFER Figure 5



## TIMING DIAGRAM: WRITE DATA TRANSFER Figure 6

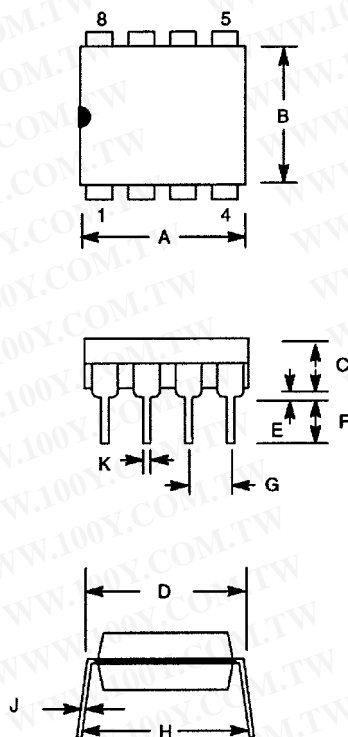


### NOTES:

1.  $I_{CC1T}$  and  $I_{CC2T}$  are specified with I/O open,  $\overline{RST}$  set to a logic 0, and clock halt flag = 0 (oscillator enabled).
2.  $I_{CC1A}$  and  $I_{CC2A}$  are specified with the I/O pin open,  $\overline{RST}$  high,  $SCLK=2MHz$  at  $V_{CC} = 5V$ ;  $SCLK = 500kHz$ ,  $V_{CC} = 2.0V$ , and clock halt flag = 0 (oscillator enabled).
3.  $\overline{RST}$ ,  $SCLK$ , and I/O all have  $40k\Omega$  pull-down resistors to ground.
4. Measured at  $V_{IH} = 2.0V$  or  $V_{IL} = 0.8V$  and 10ns maximum rise and fall time.
5. Measured at  $V_{OH} = 2.4V$  or  $V_{OL} = 0.4V$ .
6. Load capacitance = 50pF.
7.  $I_{CC1S}$  and  $I_{CC2S}$  are specified with  $\overline{RST}$ , I/O, and  $SCLK$  open. The clock halt flag must be set to logic one (oscillator disabled).
8.  $V_{CC} = V_{CC2}$ , when  $V_{CC2} > V_{CC1} + 0.2V$ ;  $V_{CC} = V_{CC1}$ , when  $V_{CC1} > V_{CC2}$ .
9.  $V_{CC2} = 0V$ .
10.  $V_{CC1} = 0V$ .
11. Typical values are at  $25^{\circ}C$ .

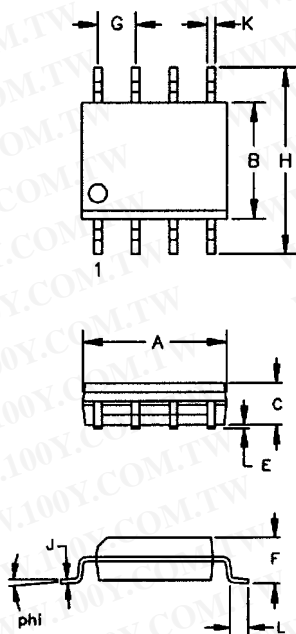
勝特力材料 886-3-5753170  
 勝特力电子(上海) 86-21-54151736  
 勝特力电子(深圳) 86-755-83298787  
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**DS1302 SERIAL TIMEKEEPER 8-PIN DIP (300-MIL)**

PKG	8-PIN	
DIM	MIN	MAX
A IN.	0.360	0.400
MM	9.14	10.16
B IN.	0.240	0.260
MM	6.10	6.60
C IN.	0.120	0.140
MM	3.05	3.56
D IN.	0.300	0.325
MM	7.62	8.26
E IN.	0.015	0.040
MM	0.38	1.02
F IN.	0.120	0.140
MM	3.04	3.56
G IN.	0.090	0.110
MM	2.29	2.79
H IN.	0.320	0.370
MM	8.13	9.40
J IN.	0.008	0.012
MM	0.20	0.30
K IN.	0.015	0.021
MM	0.38	0.53

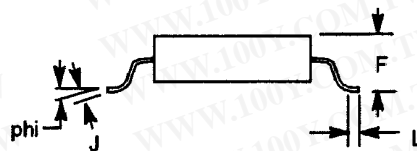
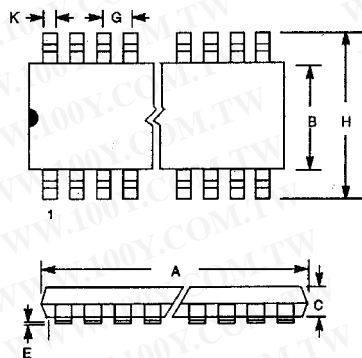
勝特力材料 886-3-5753170  
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 勝特力电子(深圳) 86-755-83298787  
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**DS1302S SERIAL TIMEKEEPER 8-PIN SOIC (150-MIL AND 200-MIL)**

PKG	8-PIN (150-MIL)		8-PIN (200-MIL)	
DIM	MIN	MAX	MIN	MAX
A IN.	0.188	0.196	0.203	0.213
MM	4.78	4.98	5.16	5.41
B IN.	0.150	0.158	0.203	0.213
MM	3.81	4.01	5.16	5.41
C IN.	0.048	0.062	0.070	0.074
MM	1.22	1.57	1.78	1.88
E IN.	0.004	0.010	0.004	0.010
MM	0.10	0.25	0.10	0.25
F IN.	0.053	0.069	0.074	0.084
MM	1.35	1.75	1.88	2.13
G IN.	0.050 BSC			
MM	1.27 BSC			
H IN.	0.230	0.244	0.302	0.318
MM	5.84	6.20	7.67	8.08
J IN.	0.007	0.011	0.006	0.010
MM	0.18	0.28	0.15	0.25
K IN.	0.012	0.020	0.013	0.020
MM	0.30	0.51	0.33	0.51
L IN.	0.016	0.050	0.019	0.030
MM	0.41	1.27	0.48	0.76
phi	0°	8°	0°	8°

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## DS1302S SERIAL TIMEKEEPER 16-PIN SOIC



PKG		16-PIN	
DIM		MIN	MAX
A	IN	0.398	0.412
	MM	10.11	10.46
B	IN	0.290	0.300
	MM	7.37	7.62
C	IN	0.089	0.095
	MM	2.26	2.41
E	IN	0.004	0.012
	MM	0.102	0.30
F	IN	0.004	0.105
	MM	2.39	2.67
G	IN	0.050 BSC	
	MM	1.27 BSC	
H	IN	0.398	0.416
	MM	10.11	10.57
J	IN	0.009	0.013
	MM	0.229	0.33
K	IN	0.013	0.020
	MM	0.33	0.51
L	IN	0.016	0.040
	MM	0.40	1.02
phi		0°	8°

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